## HEF4517B

Dual 64-bit static shift register
Rev. 7 - 11 November 2011
Product data sheet

## 1. General description

The HEF4517B consists of two identical, independent 64-bit static shift registers. Each register has separate clock (nCP), data input (nD), parallel input-enable/output-enable (nPE/ $\overline{\mathrm{OE}}$ ) and four 3-state outputs of the 16th, 32nd, 48th, and 64th bit positions (nQ16 to nQ64). Data at the nD input is entered into the first bit on the LOW-to-HIGH transition of the clock, regardless of the state of nPE/OE.

When $\mathrm{nPE} / \overline{\mathrm{OE}}$ is LOW, the outputs are enabled and it is in the 64 -bit serial mode.
When nPE/ $\overline{\mathrm{OE}}$ is HIGH , the outputs are disabled (high-impedance OFF-state), the 64-bit shift register is divided into four 16-bit shift registers with nD, nQ16, nQ32 and nQ48 as data inputs of the 1st, 17th, 33rd, and 49th bit respectively. Schmitt-trigger action in the clock input makes the circuit highly tolerant of slower clock rise and fall times.

It operates over a recommended $\mathrm{V}_{\mathrm{DD}}$ power supply range of 3 V to 15 V referenced to $\mathrm{V}_{\mathrm{SS}}$ (usually ground). Unused inputs must be connected to $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}$, or another input.

## 2. Features and benefits

■ Tolerant of slow clock rise and fall times

- Fully static operation
- 5 V , 10 V , and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
- Complies with JEDEC standard JESD 13-B


## 3. Ordering information

Table 1. Ordering information
All types operate from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$

| Type number | Package |  |  |
| :--- | :--- | :--- | :--- | :--- |
|  | Name | Description | Version |
| HEF4517BP | DIP16 | plastic dual in-line package; 16 leads (300 mil) | SOT38-4 |
| HEF4517BT | SO16 | plastic small outline package; 16 leads; body width 7.5 mm | SOT162-1 |

## 4. Functional diagram



Fig 1. Functional diagram


Fig 2. Logic diagram

## 5. Pinning information

### 5.1 Pinning



Fig 3. Pin configuration

### 5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
| :--- | :--- | :--- |
| 1Q16, 2Q16 | 1,15 | 3-state input/output |
| 1Q48, 2Q48 | 2,14 | 3-state input/output |
| 1PE/OE, 2PE/OE | 3,13 | parallel input-enable/output-enable input |
| $1 C P, 2 C P$ | 4,12 | clock input |
| $1 Q 64,2 Q 64$ | 5,11 | 3-state input/output |
| $1 Q 32,2$ Q32 | 6,10 | 3-state input/output |
| $1 D, 2 D$ | 7,9 | data input |
| $V_{\text {SS }}$ | 8 | ground supply voltage |
| $V_{D D}$ | 16 | supply voltage |

## 6. Functional description

Table 3. Function table[1]

| Inputs |  |  | Inputs/outputs |  |  |  | Mode |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| nCP | nD | nPE/OE | nQ16 | nQ32 | nQ48 | nQ64 |  |
| $\uparrow$ | data entered into 1st bit | L | content of 16th bit displayed | content of 32nd bit displayed | content of 48th bit displayed | content of 64th bit displayed | One 64-bit shift register. The content of the shift register is shifted over one stage |
| $\uparrow$ | data entered into 1st bit | H | data at nQ16 entered into 17th bit | data at nQ32 entered into 33rd bit | data at nQ 48 entered into 49th bit | remains in ' $Z$ ' <br> state | Four 16 -bit shift register. The content of the shift registers is shifted over one stage |
| $\downarrow$ | $x$ | L | no change | no change | no change | no change | no change |
| $\downarrow$ | X | H | Z | Z | Z | Z | no change |

[1] $H=$ HIGH voltage level; $L=$ LOW voltage level; $X=$ don't care; $Z=$ high-impedance state;
$\uparrow=$ positive-going transition; $\downarrow=$ negative-going transition.

## 7. Limiting values

Table 4. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | supply voltage |  | -0.5 | +18 | V |
| $\mathrm{I}_{\mathrm{K}}$ | input clamping current | $\mathrm{V}_{1}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ | - | $\pm 10$ | mA |
| $V_{1}$ | input voltage |  | -0.5 | $V_{D D}+0.5$ | V |
| lok | output clamping current | $\mathrm{V}_{\mathrm{O}}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ | - | $\pm 10$ | mA |
| $\mathrm{I}_{1 / \mathrm{O}}$ | input/output current |  | - | $\pm 10$ | mA |
| $\mathrm{I}_{\mathrm{DD}}$ | supply current |  | - | 50 | mA |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Tamb | ambient temperature |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{P}_{\text {tot }}$ | total power dissipation | DIP16 package | [1] - | 750 | mW |
|  |  | SO16 package | [2] - | 500 | mW |
| P | power dissipation | per output | - | 100 | mW |

[1] For DIP16 package: $P_{\text {tot }}$ derates linearly with $12 \mathrm{~mW} / \mathrm{K}$ above $70^{\circ} \mathrm{C}$.
[2] For SO16 package: $\mathrm{P}_{\text {tot }}$ derates linearly with $8 \mathrm{~mW} / \mathrm{K}$ above $70^{\circ} \mathrm{C}$.

## 8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $V_{D D}$ | supply voltage |  | 3 | - | 15 | V |
| $\mathrm{~V}_{1}$ | input voltage |  | 0 | - | $\mathrm{V}_{\mathrm{DD}}$ | V |
| $\mathrm{T}_{\mathrm{amb}}$ | ambient temperature | in free air | -40 | - | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta \mathrm{t} / \Delta \mathrm{V}$ | input transition rise and fall rate | $\mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}$ | - | - | 3.75 | $\mu \mathrm{~s} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=10 \mathrm{~V}$ | - | - | 0.5 | $\mu \mathrm{~s} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}$ | - | - | 0.08 | $\mu \mathrm{~s} / \mathrm{V}$ |

## 9. Static characteristics

Table 6. Static characteristics
$V_{S S}=0 V ; V_{I}=V_{S S}$ or $V_{D D}$ unless otherwise specified.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{DD}}$ | $\mathrm{Tamb}=-40^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\text {amb }}=25^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\text {amb }}=85^{\circ} \mathrm{C}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max | Min | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\left\|\mathrm{l}_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | V |
|  |  |  | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | V |
|  |  |  | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\mid \mathrm{I}_{\mathrm{O}} \mathrm{l}$ < $1 \mu \mathrm{~A}$ | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | V |
|  |  |  | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | V |
|  |  |  | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\left\|\mathrm{O}_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | 4.95 | - | 4.95 | - | 4.95 | - | V |
|  |  |  | 10 V | 9.95 | - | 9.95 | - | 9.95 | - | V |
|  |  |  | 15 V | 14.95 | - | 14.95 | - | 14.95 | - | V |
| $\mathrm{V}_{\text {OL }}$ | LOW-level output voltage | $\mid \mathrm{lo} \mathrm{l}<1 \mu \mathrm{~A}$ | 5 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
|  |  |  | 10 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
|  |  |  | 15 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
| IOH | HIGH-level output current | $\mathrm{V}_{\mathrm{O}}=2.5 \mathrm{~V}$ | 5 V | - | -1.7 | - | -1.4 | - | -1.1 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=4.6 \mathrm{~V}$ | 5 V | - | -0.52 | - | -0.44 | - | -0.36 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=9.5 \mathrm{~V}$ | 10 V | - | -1.3 | - | -1.1 | - | -0.9 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=13.5 \mathrm{~V}$ | 15 V | - | -3.6 | - | -3.0 | - | -2.4 | mA |
| $\mathrm{l}_{\mathrm{OL}}$ | LOW-level output current | $\mathrm{V}_{\mathrm{O}}=0.4 \mathrm{~V}$ | 5 V | 0.52 | - | 0.44 | - | 0.36 | - | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ | 10 V | 1.3 | - | 1.1 | - | 0.9 | - | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=1.5 \mathrm{~V}$ | 15 V | 3.6 | - | 3.0 | - | 2.4 | - | mA |
| 1 | input leakage current |  | 15 V | - | $\pm 0.3$ | - | $\pm 0.3$ | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $I_{\text {D }}$ | supply current | $\mathrm{I}_{0}=0 \mathrm{~A}$ | 5 V | - | 50 | - | 50 | - | 375 | $\mu \mathrm{A}$ |
|  |  |  | 10 V | - | 100 | - | 100 | - | 750 | $\mu \mathrm{A}$ |
|  |  |  | 15 V | - | 200 | - | 200 | - | 1500 | $\mu \mathrm{A}$ |
| $C_{1}$ | input capacitance |  | - | - | - | - | 7.5 | - | - | pF |

## 10. Dynamic characteristics

Table 7. Dynamic characteristics
$V_{S S}=0 V$; $T_{a m b}=25^{\circ} \mathrm{C}$; for test circuit see Figure 8; unless otherwise specified.

| Symbol | Parameter | Conditions | $V_{\text {DD }}$ |  | Extrapolation formula | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $t_{\text {PHL }}$ | HIGH to LOW propagation delay | nCP to nQn; see Figure 4 | 5 V | [1] | $193 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 220 | 440 | ns |
|  |  |  | 10 V |  | $74 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 85 | 170 | ns |
|  |  |  | 15 V |  | $52 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 60 | 120 | ns |
| $t_{\text {PLH }}$ | LOW to HIGH propagation delay | nCP to nQn; see Figure 4 | 5 V | [1] | $163 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 190 | 380 | ns |
|  |  |  | 10 V |  | $64 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 75 | 150 | ns |
|  |  |  | 15 V |  | $42 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 50 | 100 | ns |
| $\mathrm{t}_{\text {PHZ }}$ | HIGH to OFF-state propagation delay | nPE/ $\overline{O E}$ to $n Q n$; see Figure 5 | 5 V |  |  | - | 40 | 80 | ns |
|  |  |  | 10 V |  |  | - | 30 | 60 | ns |
|  |  |  | 15 V |  |  | - | 25 | 50 | ns |
| $t_{\text {Pz }}$ | OFF-state to HIGH propagation delay | nPE/OE to nQn ; see Figure 5 | 5 V |  |  | - | 45 | 90 | ns |
|  |  |  | 10 V |  |  | - | 25 | 50 | ns |
|  |  |  | 15 V |  |  | - | 20 | 40 | ns |
| $t_{\text {PLZ }}$ | LOW to OFF-state propagation delay | nPE/OE to nQn; see Figure 5 | 5 V |  |  | - | 50 | 100 | ns |
|  |  |  | 10 V |  |  | - | 30 | 60 | ns |
|  |  |  | 15 V |  |  | - | 25 | 50 | ns |
| $t_{\text {PZL }}$ | OFF-state to LOW propagation delay | $\mathrm{nPE} / \overline{\mathrm{OE}}$ to nQn ; see Figure 5 | 5 V |  |  | - | 60 | 120 | ns |
|  |  |  | 10 V |  |  | - | 30 | 60 | ns |
|  |  |  | 15 V |  |  | - | 25 | 50 | ns |
| $\mathrm{t}_{\mathrm{t}}$ | transition time | nQn; <br> see Figure 6 | 5 V | [1] | $10 \mathrm{~ns}+(1.00 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 60 | 120 | ns |
|  |  |  | 10 V |  | $9 \mathrm{~ns}+(0.42 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 30 | 60 | ns |
|  |  |  | 15 V |  | $6 \mathrm{~ns}+(0.28 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 20 | 40 | ns |
| $\mathrm{t}_{\text {su }}$ | set-up time | nQn, nD to nCP; see Figure 7 | 5 V |  |  | 30 | 10 | - | ns |
|  |  |  | 10 V |  |  | 25 | 5 | - | ns |
|  |  |  | 15 V |  |  | 20 | 5 | - | ns |
| $t_{\text {h }}$ | hold time | nQn, nD to nCP; see Figure 7 | 5 V |  |  | 45 | 15 | - | ns |
|  |  |  | 10 V |  |  | 30 | 10 | - | ns |
|  |  |  | 15 V |  |  | 25 | 10 | - | ns |
| tw | pulse width | nQn, nD to nCP; see Figure 7 | 5 V |  |  | - | 95 | 190 | ns |
|  |  |  | 10 V |  |  | - | 40 | 80 | ns |
|  |  |  | 15 V |  |  | - | 30 | 60 | ns |
| $\mathrm{f}_{\text {max }}$ | maximum frequency | see Figure 7 | 5 V |  |  | 2 | 5 | - | MHz |
|  |  |  | 10 V |  |  | 6 | 12 | - | MHz |
|  |  |  | 15 V |  |  | 8 | 16 | - | MHz |

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown ( $\mathrm{C}_{\mathrm{L}}$ in pF ).

Table 8. Dynamic power dissipation $P_{D}$
$P_{D}$ can be calculated from the formulas shown. $V_{S S}=0 V ; t_{r}=t_{f} \leq 20 \mathrm{~ns} ; T_{\mathrm{amb}}=25{ }^{\circ} \mathrm{C}$.

| Symbol | Parameter | $\mathrm{V}_{\mathrm{DD}}$ | Typical formula for $\mathrm{P}_{\mathrm{D}}(\mu \mathrm{W})$ | where: |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{P}_{\mathrm{D}}$ | dynamic power dissipation | 5 V | $\mathrm{P}_{\mathrm{D}}=7000 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{\mathrm{o}} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ | $\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz , |
|  |  | 10 V | $\mathrm{P}_{\mathrm{D}}=28000 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{0} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ | $\mathrm{f}_{\mathrm{o}}=$ output frequency in MHz , |
|  |  | 15 V | $\mathrm{P}_{\mathrm{D}}=70000 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{0} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ | $\mathrm{C}_{\mathrm{L}}=$ output load capacitance in pF , <br> $\mathrm{V}_{\mathrm{DD}}=$ supply voltage in V , <br> $\Sigma\left(\mathrm{f}_{\mathrm{o}} \times \mathrm{C}_{\mathrm{L}}\right)=$ sum of the outputs. |

## 11. Waveforms



Measurement points are given in Table 9
The logic levels $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ are typical voltage output levels that occur with the output load.
Fig 4. Propagation delays for nCP to nQn

Table 9. Measurement points

| Input | Output |  |  |
| :--- | :--- | :--- | :--- |
| $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{M}}$ | $\mathbf{V}_{\mathbf{X}}$ | $\mathbf{V}_{\mathbf{Y}}$ |
| $0.5 \mathrm{~V}_{\mathrm{I}}$ | $0.5 \mathrm{~V}_{\mathrm{DD}}$ | $0.1 \mathrm{~V}_{\mathrm{DD}}$ | $0.9 \mathrm{~V}_{\mathrm{DD}}$ |



Measurement points are given in Table 9
The logic levels $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ are typical voltage output levels that occur with the output load.
Fig 5. Enable and disable times and 3-state propagation delays


The logic levels $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ are typical voltage output levels that occur with the output load.
Fig 6. Transition times for nQn


The shading indicates where the data ( nQn and nD ) is permitted to change for predictable output changes.
Measurement points are given in Table 9
The logic levels $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ are typical voltage output levels that occur with the output load.
Fig 7. Waveforms showing minimum clock pulse width and maximum frequency and set-up and hold times for nQn (as data input) or nD to nCP

a. Input waveforms

b. Test circuit

Test data is given in Table 10.
Definitions for test circuit:
DUT = Device Under Test;
$\mathrm{R}_{\mathrm{L}}=$ Load resistance;
$C_{L}=$ Load capacitance including jig and probe capacitance;
$R_{T}=$ Termination resistance should be equal to output impedance $Z_{0}$ of the pulse generator.
Fig 8. Test circuit for switching times

Table 10. Test data

| Supply voltage | Input |  | Load |  | $\mathrm{V}_{\text {EXT }}$ |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{V}_{1}$ | $\mathrm{tr}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathrm{R}_{\mathrm{L}}$ | $\mathrm{t}_{\text {PLH }}, \mathrm{t}_{\text {PHL }}$ | $\mathrm{t}_{\text {PLZ }}, \mathrm{t}_{\text {PZL }}$ | $\mathrm{t}_{\text {PHZ }}, \mathrm{t}_{\text {PZH }}$ |
| 5 V to 15 V | $V_{\text {DD }}$ | $\leq 20 \mathrm{~ns}$ | 50 pF | $1 \mathrm{k} \Omega$ | open | $2 V_{\text {DD }}$ | GND |

## 12. Package outline



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | $A_{1}$ min. | $A_{2}$ max. | b | $\mathrm{b}_{1}$ | $\mathrm{b}_{2}$ | C | $D^{(1)}$ | $E^{(1)}$ | e | $e_{1}$ | L | $M_{E}$ | $\mathbf{M}_{\mathbf{H}}$ | w | $Z^{(1)}$ <br> max. |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 4.2 | 0.51 | 3.2 | $\begin{aligned} & 1.73 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & 0.53 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 1.25 \\ & 0.85 \end{aligned}$ | $\begin{aligned} & 0.36 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & 19.50 \\ & 18.55 \end{aligned}$ | $\begin{aligned} & 6.48 \\ & 6.20 \end{aligned}$ | 2.54 | 7.62 | $\begin{aligned} & 3.60 \\ & 3.05 \end{aligned}$ | $\begin{aligned} & 8.25 \\ & 7.80 \end{aligned}$ | $\begin{gathered} 10.0 \\ 8.3 \end{gathered}$ | 0.254 | 0.76 |
| inches | 0.17 | 0.02 | 0.13 | $\begin{aligned} & 0.068 \\ & 0.051 \end{aligned}$ | $\begin{aligned} & 0.021 \\ & 0.015 \end{aligned}$ | $\begin{aligned} & 0.049 \\ & 0.033 \end{aligned}$ | $\begin{aligned} & 0.014 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.77 \\ & 0.73 \end{aligned}$ | $\begin{aligned} & 0.26 \\ & 0.24 \end{aligned}$ | 0.1 | 0.3 | $\begin{aligned} & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.31 \end{aligned}$ | $\begin{aligned} & 0.39 \\ & 0.33 \end{aligned}$ | 0.01 | 0.03 |

Note

1. Plastic or metal protrusions of 0.25 mm ( 0.01 inch ) maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT38-4 |  |  |  | $\square$ ¢ | $\begin{aligned} & -95-01-14 \\ & 03-02-13 \end{aligned}$ |

Fig 9. Package outline SOT38-4 (DIP16)


DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $\mathrm{L}_{\mathrm{p}}$ | Q | v | w | y | $\mathrm{z}^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 2.65 | $\begin{aligned} & 0.3 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & \hline 2.45 \\ & 2.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & 10.5 \\ & 10.1 \end{aligned}$ | $\begin{aligned} & 7.6 \\ & 7.4 \end{aligned}$ | 1.27 | $\begin{aligned} & \hline 10.65 \\ & 10.00 \end{aligned}$ | 1.4 | $\begin{aligned} & 1.1 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 1.1 \\ & 1.0 \end{aligned}$ | 0.25 | 0.25 | 0.1 | $\begin{aligned} & 0.9 \\ & 0.4 \end{aligned}$ | $8^{\circ}$ |
| inches | 0.1 | $\begin{array}{\|l} 0.012 \\ 0.004 \end{array}$ | $\begin{aligned} & 0.096 \\ & 0.089 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{aligned} & 0.013 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.41 \\ & 0.40 \end{aligned}$ | $\begin{aligned} & 0.30 \\ & 0.29 \end{aligned}$ | 0.05 | $\begin{aligned} & 0.419 \\ & 0.394 \end{aligned}$ | 0.055 | $\begin{aligned} & 0.043 \\ & 0.016 \end{aligned}$ | $\begin{aligned} & 0.043 \\ & 0.039 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & 0.035 \\ & 0.016 \end{aligned}$ | $0^{\circ}$ |

Note

1. Plastic or metal protrusions of 0.15 mm ( 0.006 inch) maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT162-1 | 075E03 | MS-013 |  | $\bigcirc$ | $\begin{aligned} & \hline-99-12-27 \\ & 03-02-19 \end{aligned}$ |

Fig 10. Package outline SOT162-1 (SO16)

## 13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :---: | :---: | :---: | :---: | :---: |
| HEF4517B v. 7 | 20111111 | Product data sheet | - | HEF4517B v. 6 |
| Modifications: | - Section Applications removed <br> - Table 6: $\mathrm{I}_{\mathrm{OH}}$ minimum values changed to maximum <br> - Figure 8: added "DUT = Device Under Test" |  |  |  |
| HEF4517B v. 6 | 20091210 | Product data sheet | - | HEF4517B v. 5 |
| HEF4517B v. 5 | 20090728 | Product data sheet | - | HEF4517B v. 4 |
| HEF4517B v. 4 | 20090406 | Product data sheet | - | HEF4517B_CNV v. 3 |
| HEF4517B_CNV v. 3 | 19950101 | Product specification | - | HEF4517B_CNV v. 2 |
| HEF4517B_CNV v. 2 | 19950101 | Product specification | - | - |

## 14. Legal information

### 14.1 Data sheet status

| Document status $\underline{[1][2]}$ | Product status[3] | Definition |
| :--- | :--- | :--- |
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